IXYS

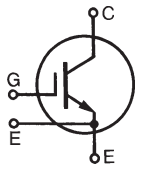
Preliminary Technical Information

GenX3™ 600V IGBT

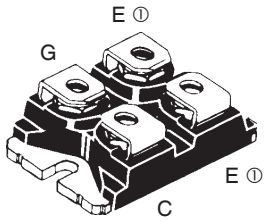
IXGN72N60A3

V_{CES} = 600V
I_{C110} = 68A
$V_{CE(sat)} \leq$ 1.35V

Ultra Low Vsat PT IGBT for
up to 5kHz switching



SOT-227B, miniBLOC
E153432



G = Gate, C = Collector, E = Emitter

①Either emitter terminal can be used as Main or Kelvin Emitter

Symbol	Test Conditions		Maximum Ratings	
V_{CES}	T_J = 25°C to 150°C		600	V
V_{CGR}	T_J = 25°C to 150°C, R_{GE} = 1MΩ		600	V
V_{GES}	Continuous		±20	V
V_{GEM}	Transient		±30	V
I_{C25}	T_C = 25°C (Chip capability)		160	A
I_{C110}	T_C = 110°C		68	A
I_{LRMS}	Terminal Current Limit		100	A
I_{CM}	T_C = 25°C, 1ms		400	A
SSOA	V_{GE} = 15V, T_{VJ} = 125°C, R_G = 3Ω		I_{CM} = 150	A
(RBSOA)	Clamped inductive load		@ 0.8 • V_{CES}	
P_C	T_C = 25°C		360	W
T_J			-55 ... +150	°C
T_{JM}			150	°C
T_{stg}			-55 ... +150	°C
V_{ISOL}	50/60Hz	t = 1min	2500	V~
	$I_{ISOL} \leq$ 1mA	t = 1s	3000	V~
M_d	Mounting torque		1.5/13	Nm/lb.in.
	Terminal connection torque (M4)		1.3/11.5	Nm/lb.in.
Weight			30	g

Symbol	Test Conditions (T_J = 25°C, unless otherwise specified)		Characteristic Values Min.	Typ.	Max.	
BV_{CES}	I_C = 250μA, V_{GE} = 0V		600			V
$V_{GE(th)}$	I_C = 250μA, V_{CE} = V_{GE}		3.0		5.0	V
I_{CES}	V_{CE} = V_{CES}				75	μA
	V_{GE} = 0V	T_J = 125°C			750	μA
I_{GES}	V_{CE} = 0V, V_{GE} = ±20V				±100	nA
$V_{CE(sat)}$	I_C = 60A, V_{GE} = 15V, Note 1				1.35	V

Features

- Optimized for low conduction losses
- Isolation voltage 3000 V~
- Square RBSOA
- International standard package

Advantages

- High power density
- Low gate drive requirement

Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- Inrush Current Protection Circuits

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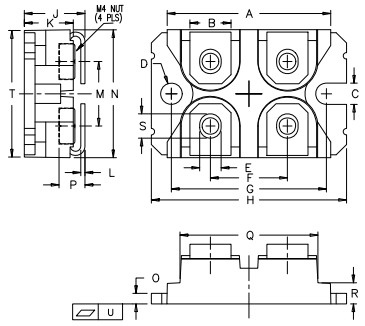
Symbol	Test Conditions (T_J = 25°C, unless otherwise specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	I_C = 60A, V_{CE} = 10V, Note 1	48	76		S
C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		6600		pF
C_{oes}			360		pF
C_{res}			80		pF
$Q_{g(on)}$	I_C = 60A, V_{GE} = 15V, V_{CE} = 0.5 • V_{CES}		230		nC
Q_{ge}			40		nC
Q_{gc}			78		nC
$t_{d(on)}$	**Inductive load, T_J = 25°C** I_C = 50A, V_{GE} = 15V V_{CE} = 480V, R_G = 3Ω		31		ns
t_{ri}			34		ns
E_{on}			1.38		mJ
$t_{d(off)}$			320		ns
t_{fi}			250		ns
E_{off}			3.5		mJ
$t_{d(on)}$	**Inductive load, T_J = 125°C** I_C = 50A, V_{GE} = 15V V_{CE} = 480V, R_G = 3Ω		29		ns
t_{ri}			32		ns
E_{on}			2.6		mJ
$t_{d(off)}$			510		ns
t_{fi}			375		ns
E_{off}			6.5		mJ
R_{thJC}				0.35	°C/W
R_{thCK}			0.05		°C/W

SOT-227B miniBLOC (IXGN)



SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	1.240	1.255	31.50	31.88
B	.307	.323	7.80	8.20
C	.161	.169	4.09	4.29
D	.161	.169	4.09	4.29
E	.161	.169	4.09	4.29
F	.587	.595	14.91	15.11
G	1.186	1.193	30.12	30.30
H	1.496	1.505	38.00	38.23
J	.460	.481	11.68	12.22
K	.351	.378	8.92	9.60
L	.030	.033	0.76	0.84
M	.496	.506	12.60	12.85
N	.990	1.001	25.15	25.42
O	.078	.084	1.98	2.13
P	.195	.235	4.95	5.97
Q	1.045	1.059	26.54	26.90
R	.155	.174	3.94	4.42
S	.186	.191	4.72	4.85
T	.968	.987	24.59	25.07
U	-.002	.004	-0.05	0.1

Note: 1. Pulse test, t ≤ 300µs; duty cycle, d ≤ 2%.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,850,072 4,881,106 4,931,844 5,017,508 5,034,796 5,049,961 5,063,307 5,187,117 5,237,481 5,381,025 5,486,715 6,162,665 6,259,123 B1 6,306,728 B1 6,404,065 B1 6,534,343 6,583,505 6,683,344 6,710,405 B2 6,710,463 6,727,585 6,759,692 6,771,478 B2 7,005,734 B2 7,063,975 B2 7,071,537 7,157,338B2

Fig. 1. Output Characteristics @ 25ºC

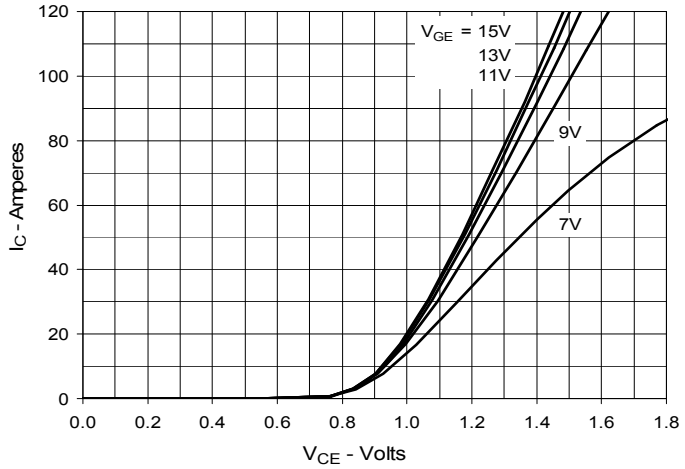

Fig. 2. Extended Output Characteristics @ 25ºC

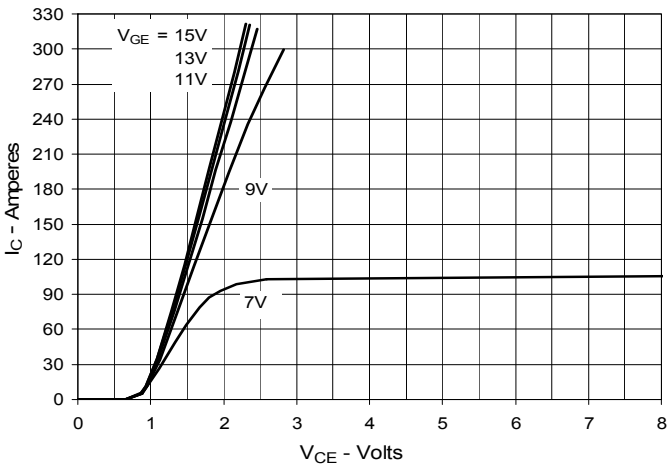

Fig. 3. Output Characteristics @ 125ºC

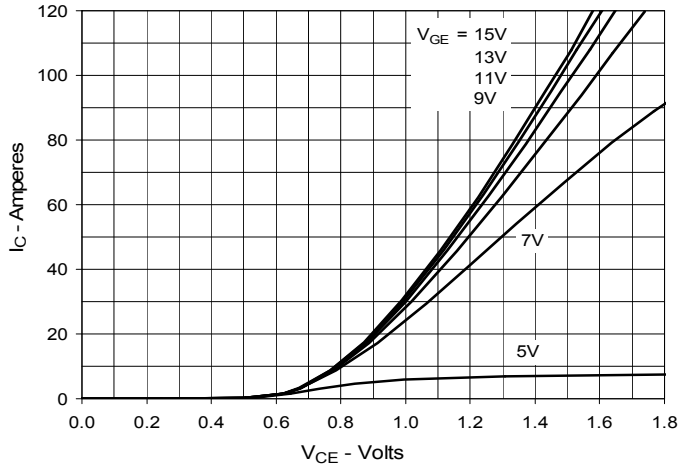

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

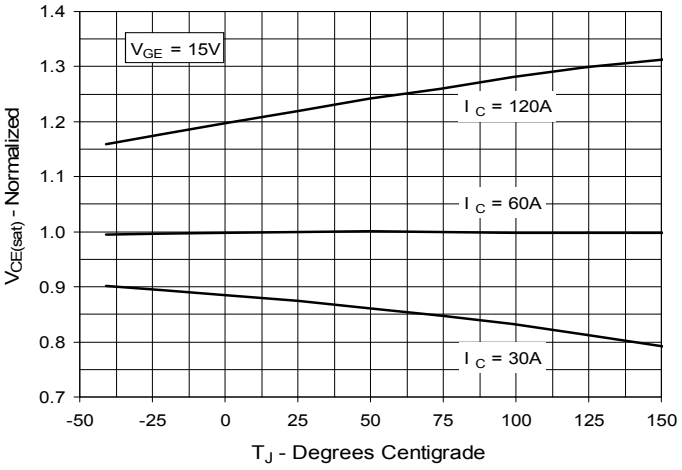

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

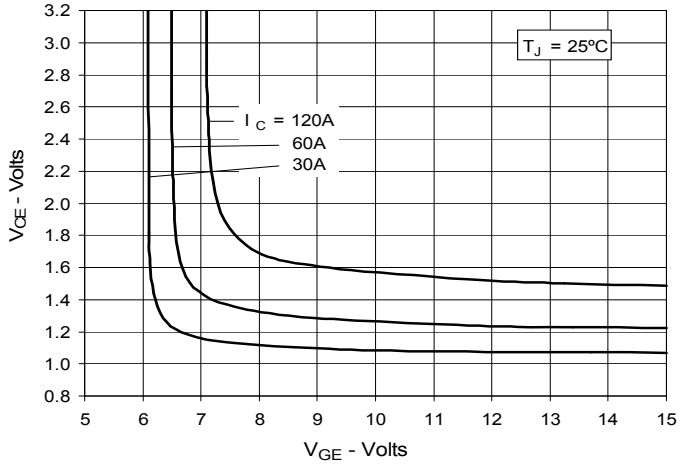

Fig. 6. Input Admittance

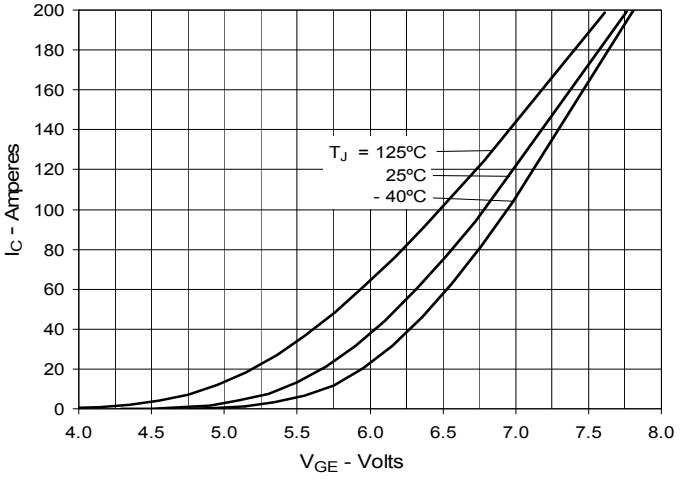

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Fig. 7. Transconductance

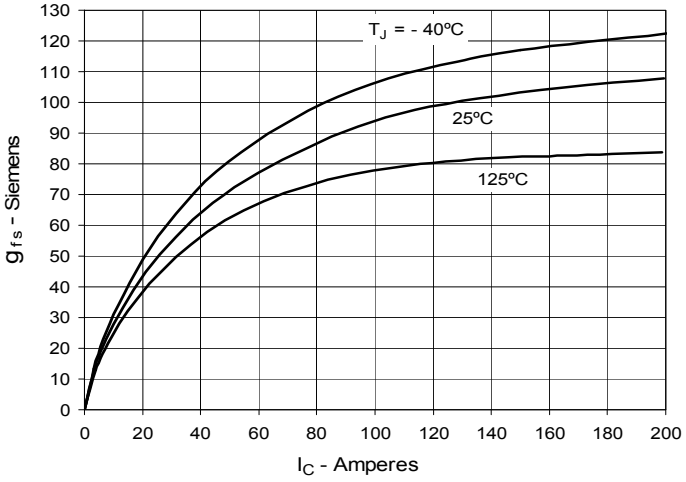

Fig. 8. Gate Charge

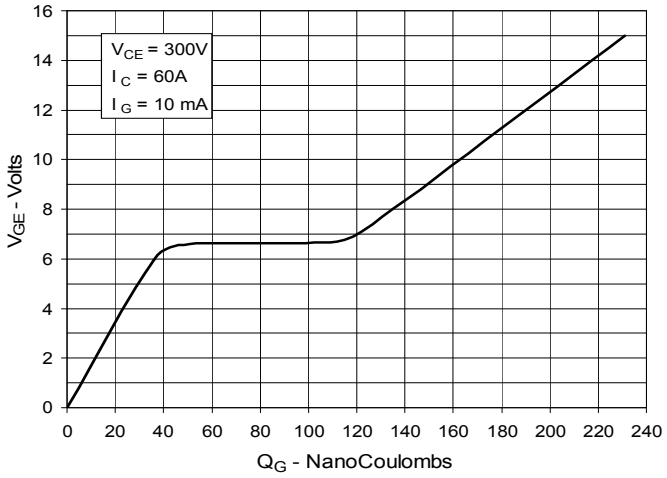

Fig. 9. Capacitance

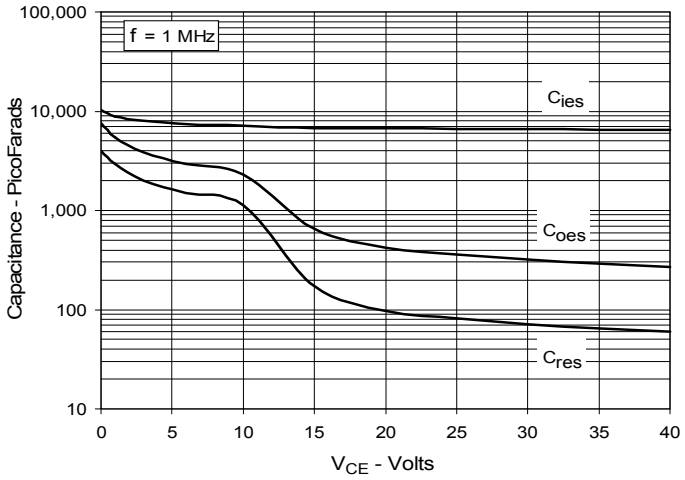

Fig. 10. Reverse-Bias Safe Operating Area

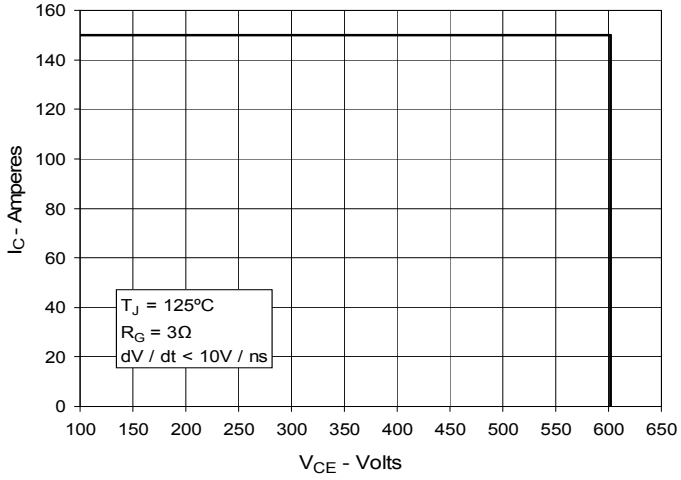

Fig. 11. Maximum Transient Thermal Impedance

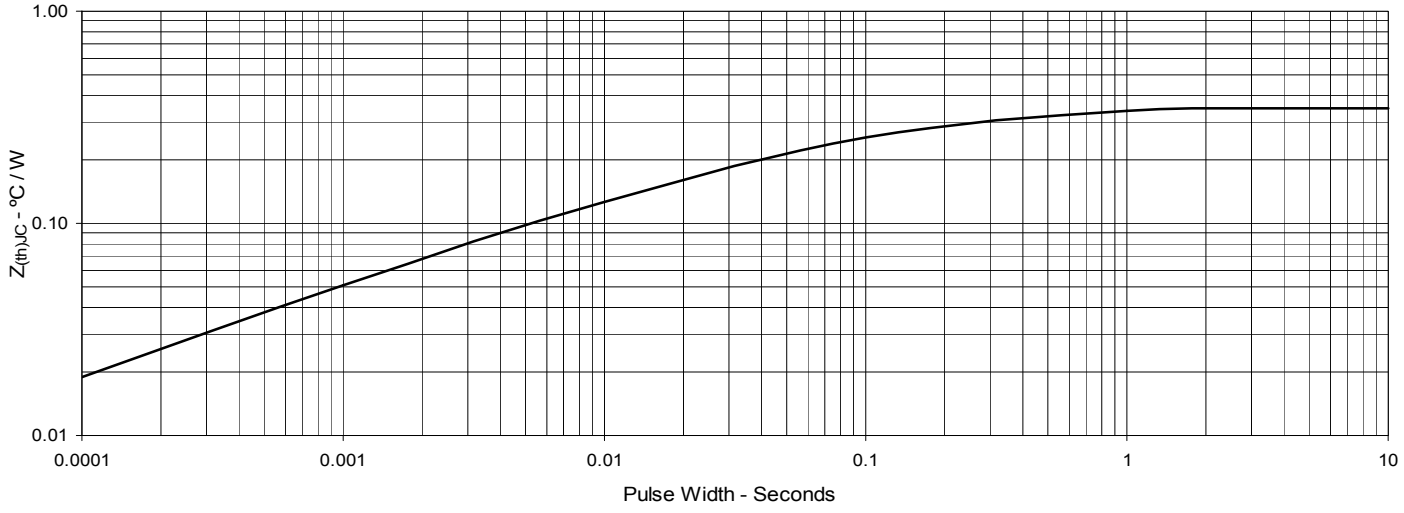

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Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance

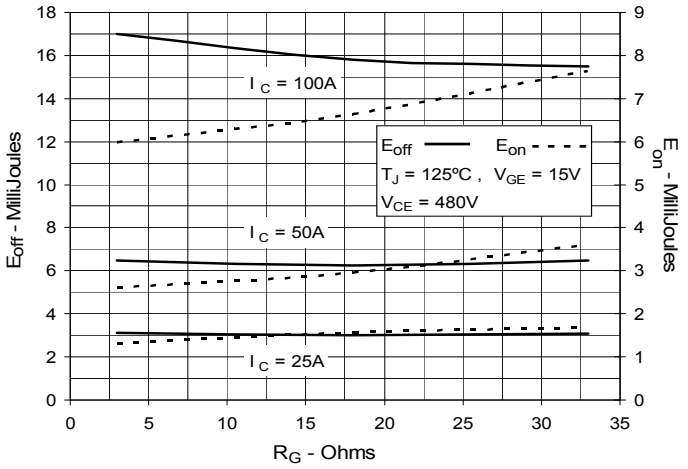

Fig. 13. Inductive Switching Energy Loss vs. Collector Current

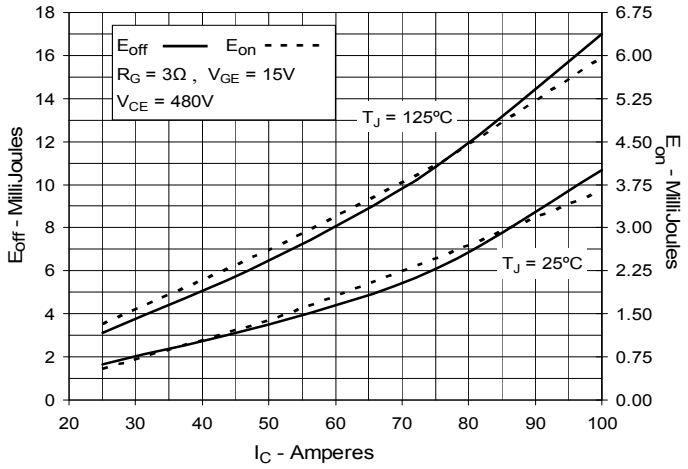

Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature

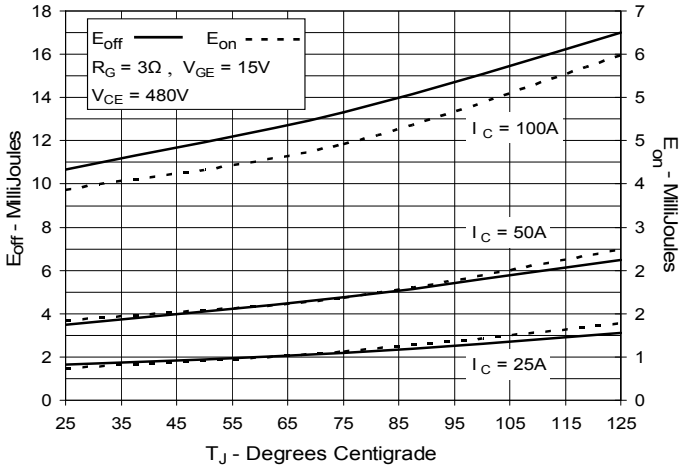

Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance

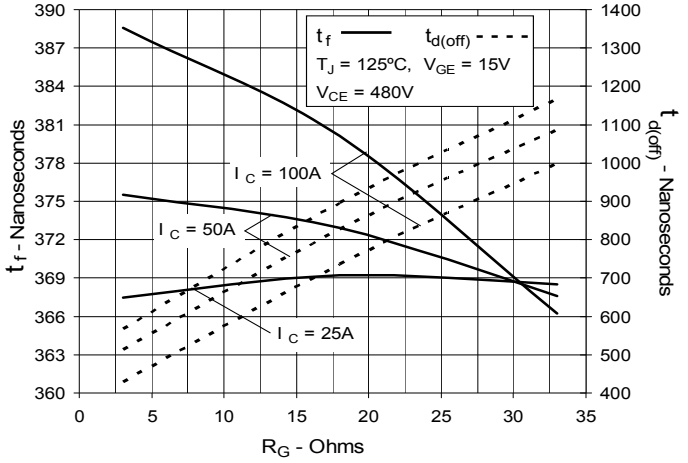

Fig. 16. Inductive Turn-off Switching Times vs. Collector Current

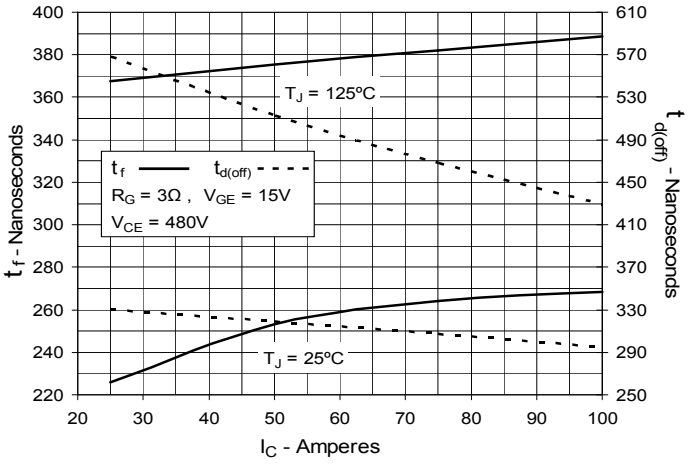

Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature

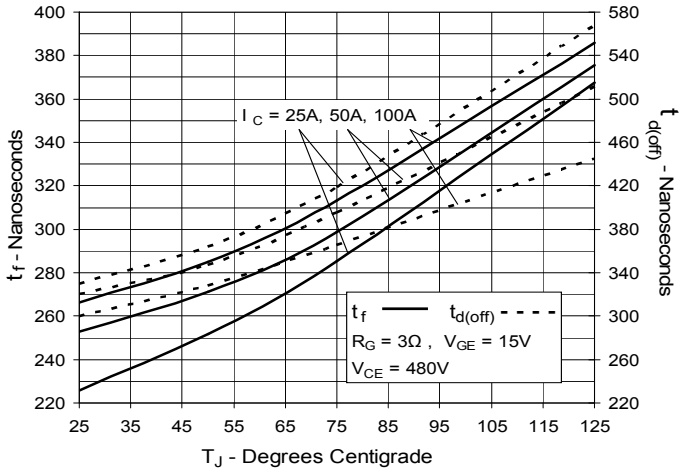

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Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance

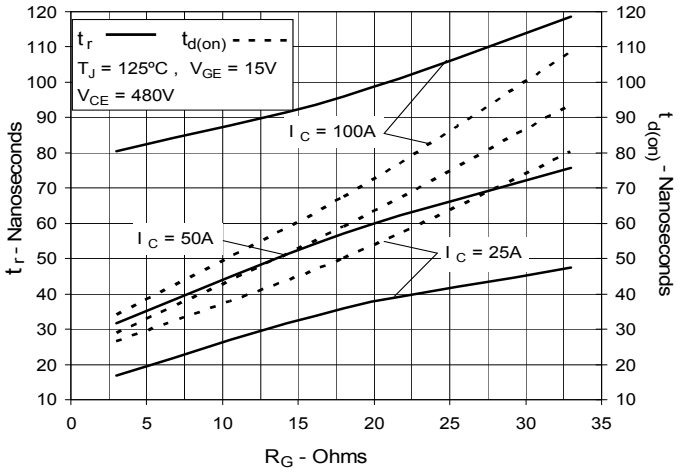


Fig. 19. Inductive Turn-on Switching Times vs. Collector Current

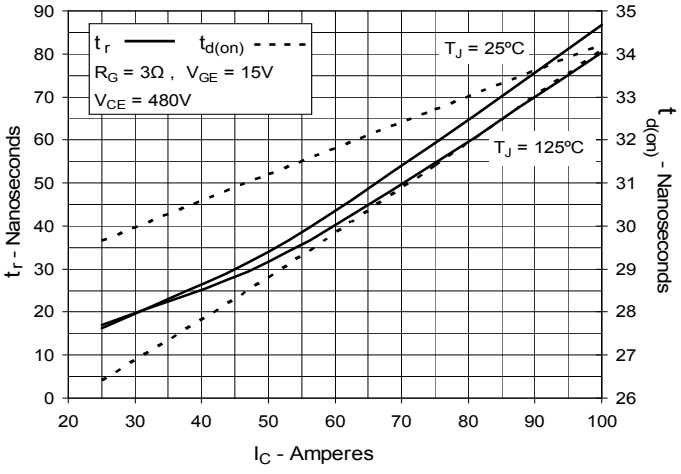
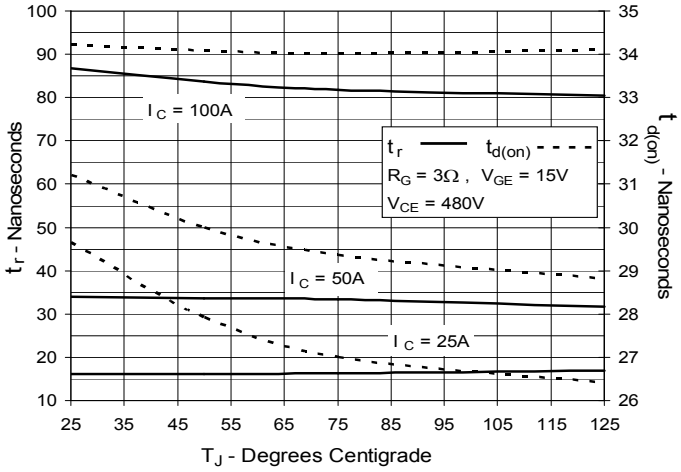


Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature



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